PRODUCT SPECIFICATION FOR LCD MODULE

Revision: 00

Model No: ATK43138

Module Type: COG+FPC+B/L+ST+TP

APPROVED SIGNATURE

□ Approved Product Specification only
■ Approved Product Specification and Samples

Prepared By	Checked By	Approved By

Contents

1. General Description

ATK43138 is a transmissive type a-Si TFT-LCD (amorphous silicon thin film transistor liquid crystal display) module, which is composed of a TFT-LCD panel, a driver circuit and a backlight unit. The panel size is 4.3 inch and the resolution is 800(RGB)*480, the panel can

display up to 16M colors. The LCM can be easily accessed by RGB interface.

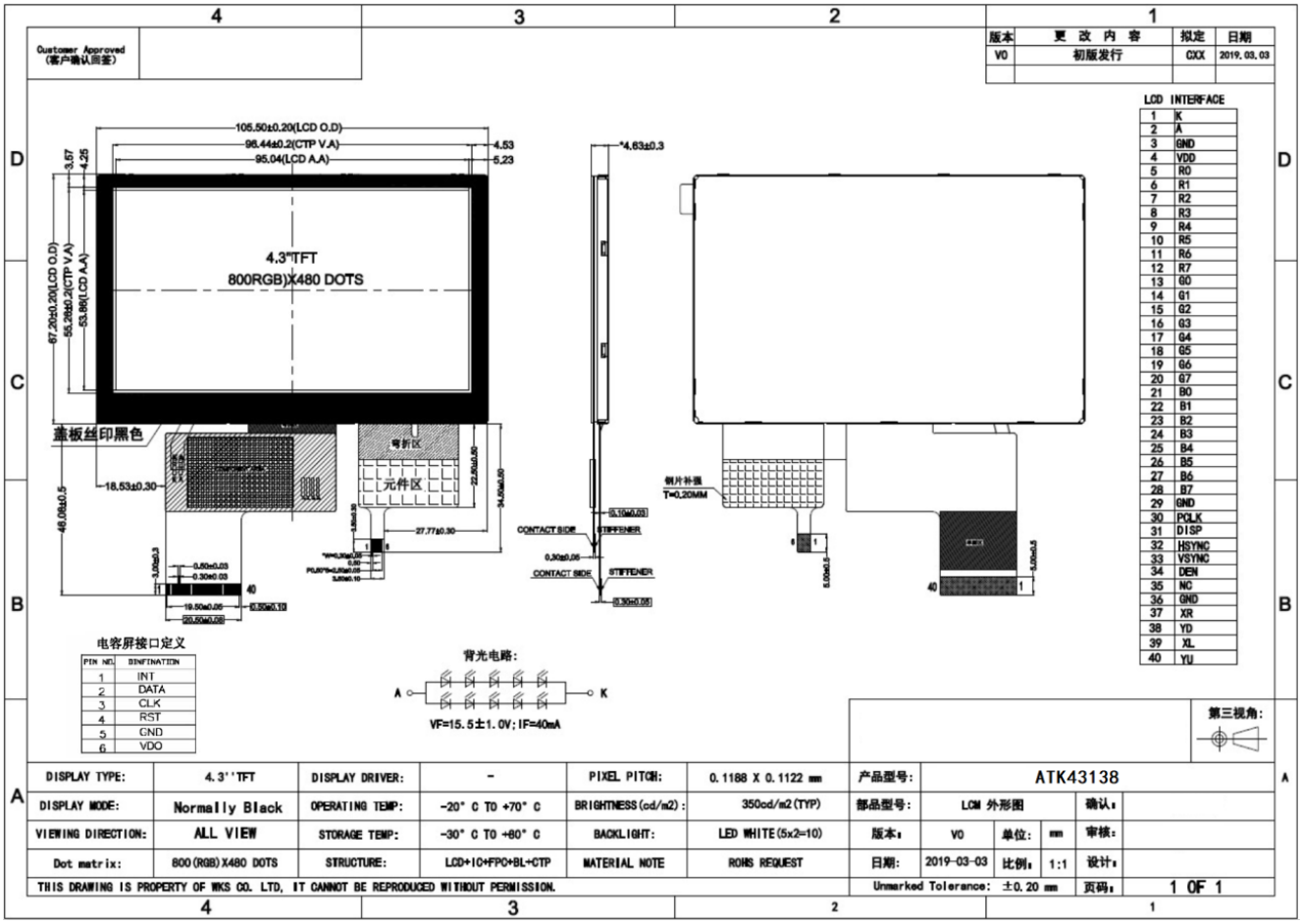
2. Physical Features

Display Mode	TFT-LCD Module
	Active matrix TFT, Transmissive type
Display Format	Graphic 800×RGB×480 Dot-matrix
Input Data	24 bit RGB interface
Viewing Direction	6 O'clock

3. Mechanical Specification

Item	Contents	Unit
Module size (W×H×T)	105.40 × 67.10× 2.90	mm
Number of dots	800(RGB) × 480	---
Active area (W×H)	95.04×53.86	mm

4. Outline Dimension



5. Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Remark
Power Voltage	VCC	0.3	5.0	V	Note1、Note2
Input Voltage	VIN	-0.3	5.0	V	
Operating temperature	TOPR	-20	70	℃	
Storage temperature	TSTR	-30	80	℃	
Humidity	---	---	90	%RH	---

Remark:

Note 1) The driver IC may be permanently damaged if it is used under the condition exceeding the above absolute maximum values. It is also recommended to use the driver IC within the limit of its electric characteristics during normal operation. Exceeding the conditions may lead to malfunction of it and affect its credibility.

Note 2) The voltage from VSS.

6. Electrical Characteristics

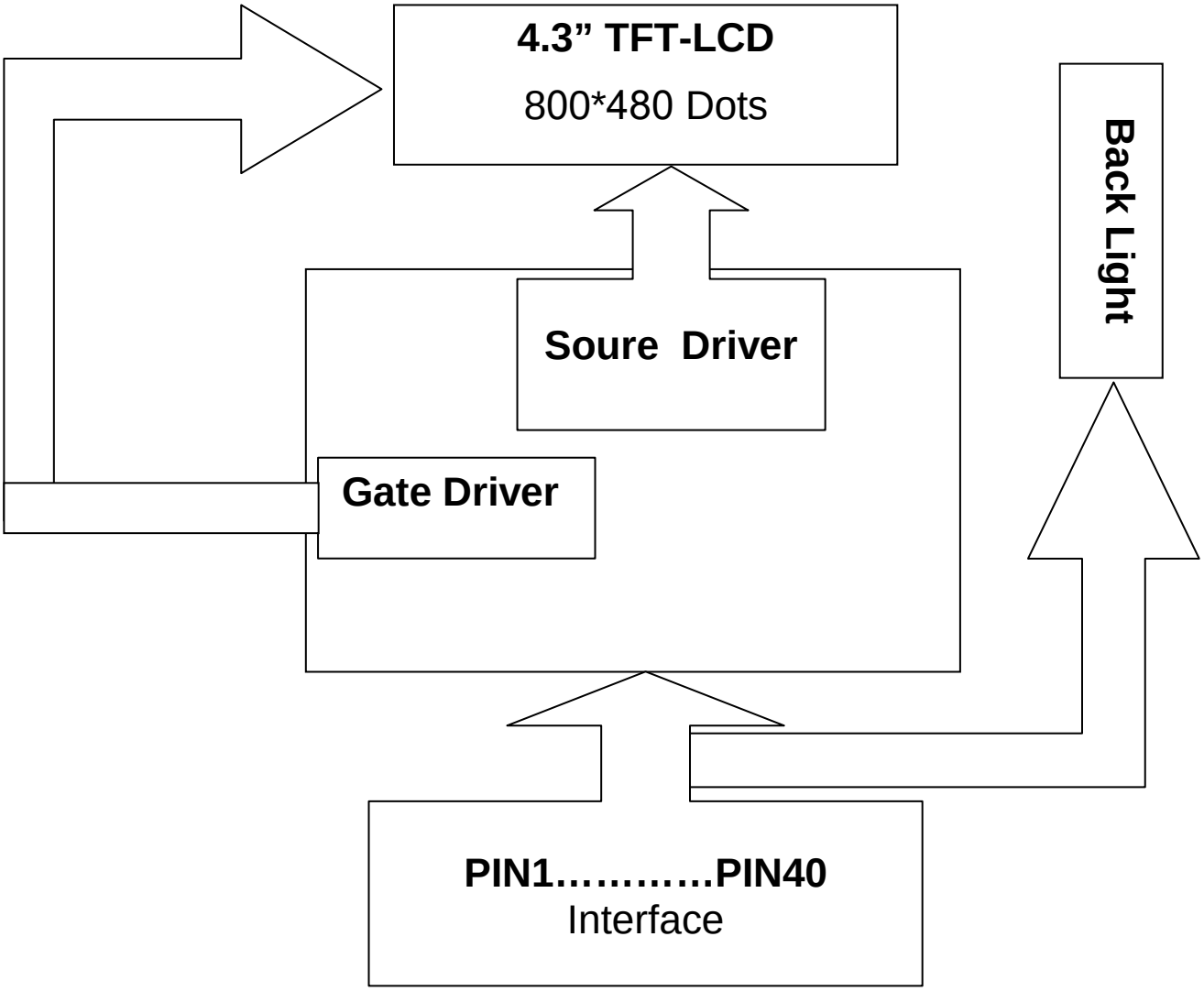
Item		Symbol	Rating			Unit	Remark
			Min	Typ	Max		
Power Voltage	Logic	VCC	3.0	3.3	3.6	V	Note1
Input Voltage	L level	VIL	GND	---	0.3*VCC	V	VCC=3.0 ~ 3.6V
	H level	VIH	0.7* VCC	---	VCC	V	
LCD Drive Power current		ILCD	---	---	24	mA	VCC=3.3V

Remark:

Note1:Vcom must be adjusted to optimize display quality: Cross-talk, Contrast Ratio and etc.

7. Module Function Description

7-1. Block Diagram Of LCM



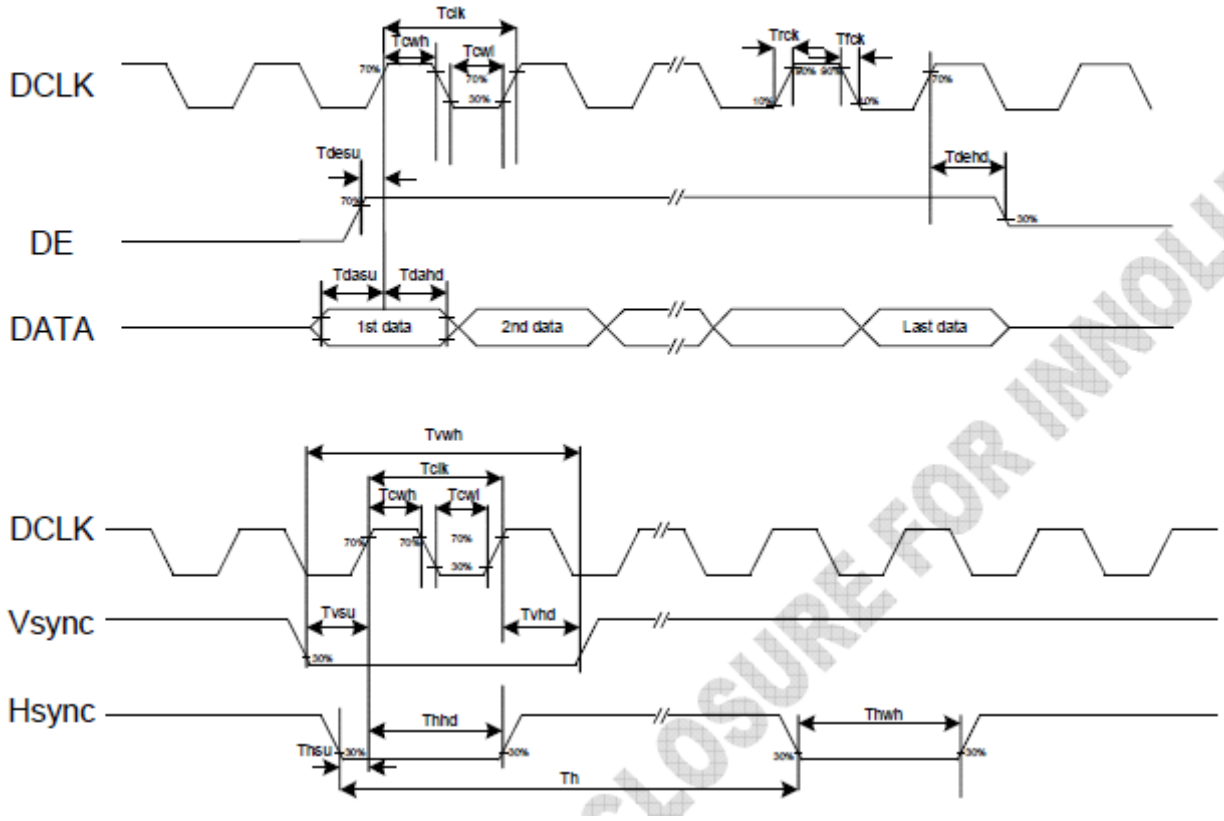
7-2. Pin Description

PIN NO.	Symbol	I/O	Description
1	K	P	Power for LED backlight cathode
2	A	P	Power for LED backlight anode

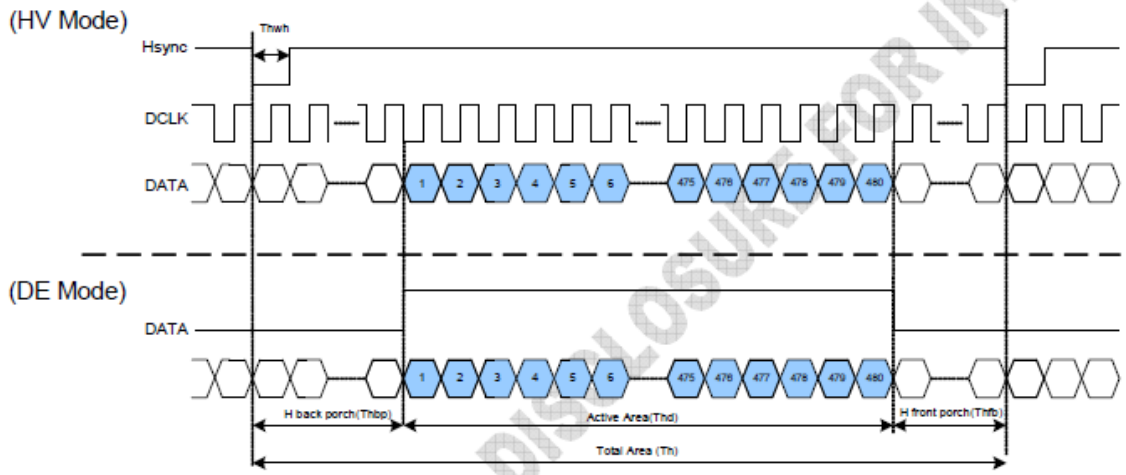
3	GND	P	Power ground
4	DVDD	P	Power voltage
5~12	R0~R7	I	Red data
13~20	G0~G7	I	Green data
21~28	B0~B7	I	Blue data
29	GND	P	Power ground
30	DCLK	I	Pixel clock
31	DISP	I	Display on/off
32	HSYNC	I	Horizontal sync signal
33	VSYNC	I	Vertical sync signal
34	DE	I	Data enable
35	NC	--	No connect
36	GND	P	Power ground
37	XR	--	TP PIN
38	YD	--	TP PIN
39	XL	--	TP PIN
40	YU	--	TP PIN

7-3. Timing Characteristics

Clock and Data Input Waveforms



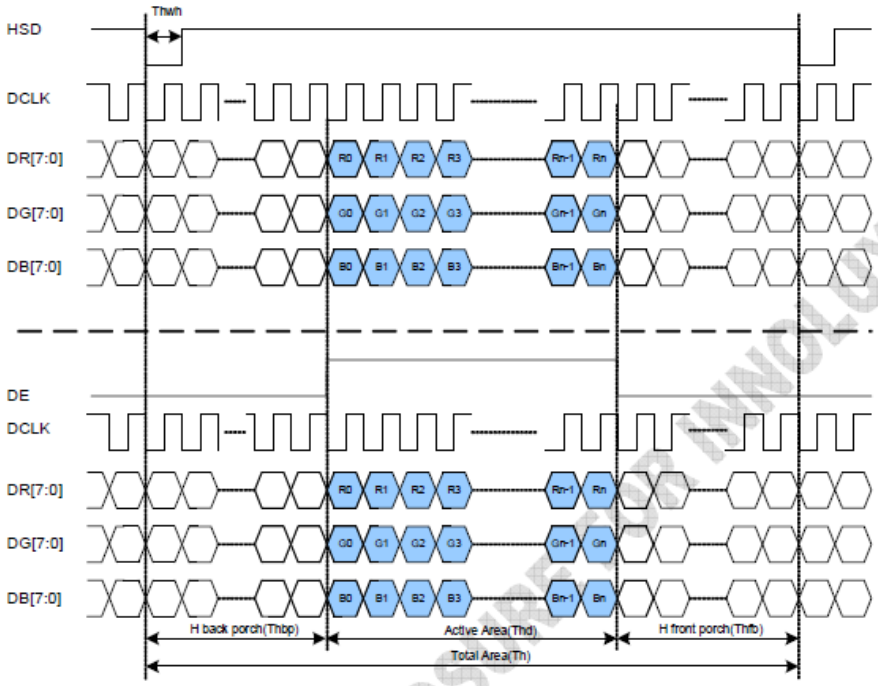
Serial 8-bit RGB Mode Data format



Parameters	Symbol	Min.	Typ.	Max.	Unit	Conditions
DCLK frequency	Fclk	24	27	30	MHz	
DCLK cycle time	Tclk	83	110	200	ns	
DCLK pulse duty	Tcwh	40	50	60	%	
Time from HSD to source output	Thso	-	13	-	DCLK	
Time from HSD to gate output	Thgo	-	27	-	DCLK	
Time from HSD to gate output off	Thgz	-	3	-	DCLK	
Time from HSD to VCOM	Thvc	-	12	-	DCLK	

Parallel RGB Mode Data format

(HV Mode)



(DE Mode)

Parallel RGB input timign table

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
DCLK frequency	fclk	5	9	12	MHz
VSD period time	Tv	277	288	400	H
VSD display area	Tvd		272		H
VSD back porch	Tvb	3	8	31	H
VSD front porch	Tvfp	2	8	97	H
HSD period time	Th	520	525	800	DCLK
HSD display area	Thd		480		DCLK
HSD back porch	Thbp	36	40	255	DCLK
HSD front porch	Thfp	4	5	65	DCLK

Serial RGB input timign table

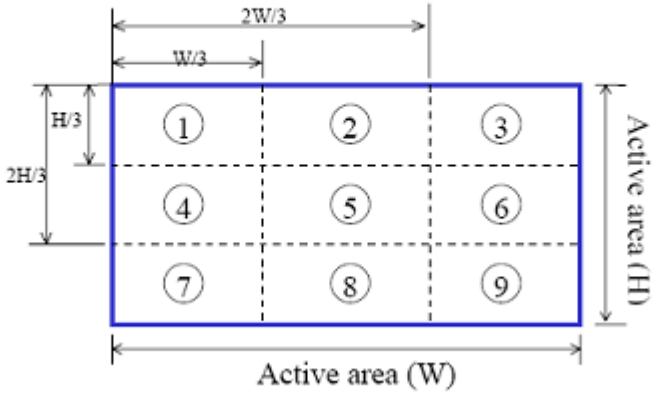
Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
DCLK frequency	fclk	-	27	-	MHz
VSD period time	Tv	277	288	400	H
VSD display area	Tvd		272		H
VSD back porch	Tvb	3	8	31	H
VSD front porch	Tvfp	2	8	97	H
HSD period time	Th	-	1728	-	DCLK
HSD display area	Thd		1440		DCLK

8. Backlight Characteristics

Item	Symbol	Min	Typ	Max	Unit	Condition	Remark
Forward voltage	V_{BL}	20.3	21.7	23.1	V	IF=40mA（恒定电流测试）	-
Current	I_{BL}	-	20	-	mA		-
ICE	X	0.26	-	0.36	-		-
	Y	0.28	-	0.38	-		
Brightness of LCM	-	170	200		cd/m²		
Uniformity	-	80	-	-	%		

★1 Uniform measure condition:

(1)Measure 9 point. Measure location is show below :
(2)Uniform = (Min. brightness / Max. brightness)×100%
(3)Best Contrast.



9. Electro-Optical Characteristics

Item	Symbol	Condition	Values			Unit	Remark
			Min.	Typ.	Max.		
Viewing angle (CR≥ 10)	θ_L	Φ=180°(9 o'clock)	60	70	-	degree	Note 1
	θ_R	Φ=0°(3 o'clock)	60	70	-		
	θ_T	Φ=90°(12 o'clock)	40	50	-		
	θ_B	Φ=270°(6 o'clock)	60	70	-		
Response time	T_{ON}	Normal θ=Φ=0°	-	10	20	msec	Note 3
	T_{OFF}		-	15	30	msec	Note 3
Contrast ratio	CR		400	500	-	-	Note 4
Color chromaticity	W_X		0.26	0.31	0.36	-	Note 2 Note 5
	W_Y		0.28	0.33	0.38	-	
Transmittance	Tr		-	6.26	-	%	

Test Conditions:

1. V_{DD}=3.3V, I_L=20mA (Backlight current), the ambient temperature is 25℃.
2. The test systems refer to Note 2.

Note 1: Definition of optical measurement system.
The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON BM-7, other items are measured by BM-5A/Field of view: 1° /Height: 500mm.)

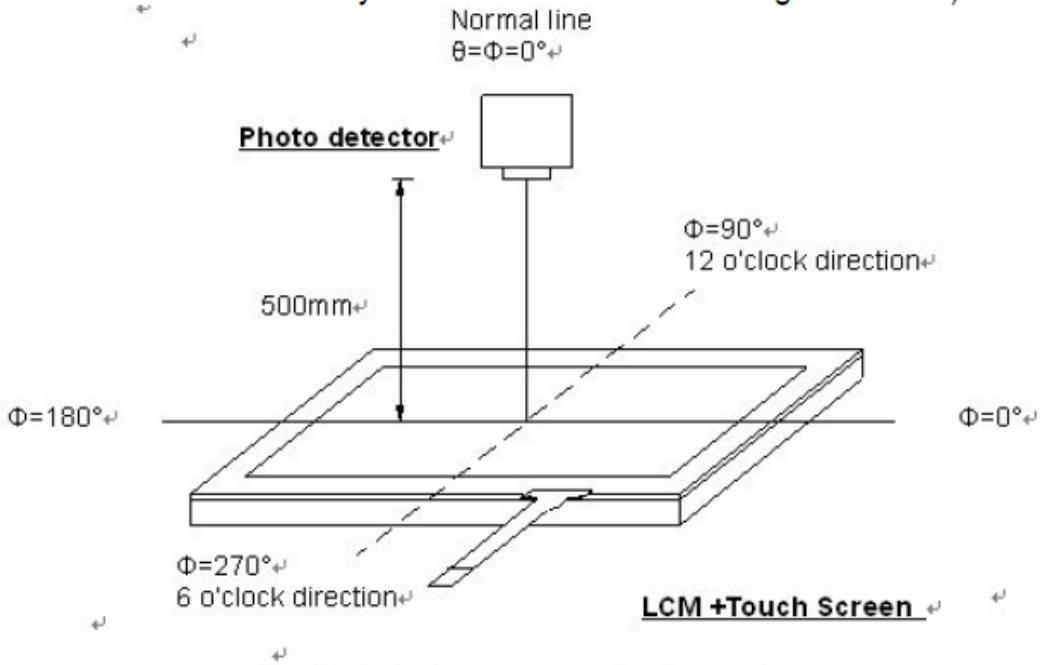


Fig. 4-2 Optical measurement system setup

Fig. Optical measurement system setup

Note 2: Definition of color chromaticity (CIE1931)
Color coordinates measured at center point of LCD.

Note 3: All input terminals LCD panel must be ground while measuring the center area of the panel. The LED driving condition is V_{LED}=5.0V.

10. Reliability

10. 1. MTBF

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal. (25°C in the room without sunlight)

10. 2. Test condition

ITEM	CONDITIONS	CRITERION
OPERATING TEMPERATURE	HIGH TEMPERTURE +70℃ 48HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
	LOW TEMPERTURE -20℃ 48HRS	
STORAGE TEMPERATURE	HIGH TEMPERTURE +80℃ 48HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION
	LOW TEMPERTURE -30℃ 48HRS	
HUMIDITY	40℃ 90%RH 48HRS	NO DEFECT IN DISPLAYING AND OPERATIONAL FUNCTION

Note：The need to restore at room temperature for 2 hours after the test。

11. Inspection Standards

1. AQL(Acceptable Quality Level)

AQL of major and minor defect

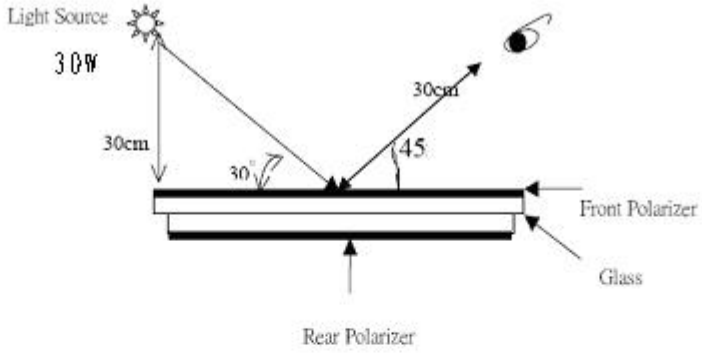
According to GB/T 2828-2003 ; , normal inspection, Class Ⅱ

MAJOR DEFECT	MINORDEFECT
0.65	1.5

2. Basic conditions for inspection

The LCM face to us, in normal environment, About an angle of incidence 30, a distance of 30cm with normal eye,with an angle of 45 degree to check the products without uncovering the film!

(As shown below)

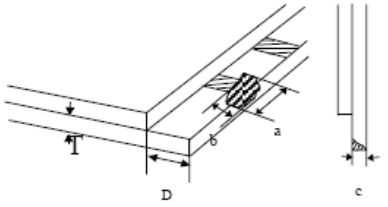
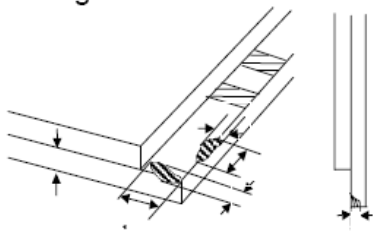


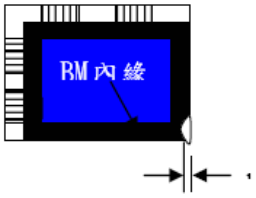
3. Inspection item and criteria

3.1 Visual inspection criterion in immobility

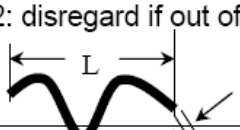
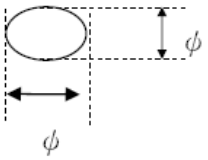
3.1.1 Glass defect

No	Defect item	Criteria	Remark
1	Dimension Unconformity (Major defect)	By Engineering Drawing	

No	Defect item	Criteria	Remark
2	Cracks (Major defect)	1.Linear cracks on panel 【Reject】 2. Nonlinear crack contrast by limited sample	
3	Glass extrude the conductive area (minor defect)	a: disregards and no influence assemblage 1) b≦1/3Pin width(non bonding area) 【Accept】 2) bonding area≦0.5mm 【Accept】	a:Length, b:Width
4	Pin-side，conductive area damaged (minor defect)	(a c：disregards) b≦ 1/3 of effective length for bonding electrode 【Accept】	a：Length，b：Width，c：Thickness 
5	Pin-side，non-conductive area damaged (minor defect)	1) Damage area don't touch the ITO (Inclueling contraposition mark,except scribing mark) 【Accept】 2) c<T b≦BM 1/3 of width 【Accept】 3) c=T b not touch the seal glue 【Accept】 4) a disregards	a：Length，b：Width，c：Thickness 

No	Defect item	Criteria	Remark
6	Non-pin-side damage (minor defect)	c<T 1) b exceeds 1/3 BM 【Reject】 c=T b not touch the seal glue 【Reject】	c : Thickness b: width of damage 

3.1.2 LCD appearance defect (View area)

No	Defect item	Criteria		Remark
1	Fiber、glass cratch、polarizer scratch/folded (minor defect)	Specification	Allowable	note1: L：Length，W：Width note2: disregard if out of AA 
		0.05mm<W≦0.1mm; L≦3.0mm	1	
		W>0.1mm ; L>3.0mm	0	
2	Polarizer bubble、concave and convex (minor defect)	ψ≦0.2mm	disregard	note 1:ψ=(L+W)/2；L：Length，W：Width note2: disregard if out of AA 
		0.2mm<ψ ≦ 0.3mm	2	
		0.3mm<ψ ≦ 0.5mm	1	
		0.5mm<ψ	0	
3	Black dots、dirty dots、impurities、eyewinker (Major defect)	ψ≦0.15mm	disregard	note2: disregard if out of AA 
		0.15mm<ψ ≦ 0.25mm	2	
		0.25mm<ψ ≦ 0.3mm	1	
		0.3mm<ψ	0	
4	Polarizer prick (Major defect)	ψ≦0.1mm	disregard	note1:ψ=(L+W)/2 ；L= Length，W=Width note2: the distance between two dots ＞5mm
		0.1mm<ψ≦0.25mm	3	
		ψ＞0.25mm	0	

3.1.3 .FPC

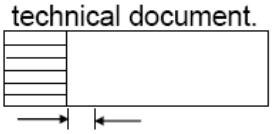
No	Defect item	Criteria		Remark
1	Copper screen peel (Major defect)	Copper screen peel 【Reject】		
2	No release tape or peel (Major defect)	No release tape or peel 【Reject】		
3	Dirty dot and impurity of FPC for customer using side (minor defect)	Specification	Allowable	note1: Cannot have stride ITO impurities
		ψ≦0.25mm	2	
		ψ>0.25	0	

3.1.4 Black tape & Mara tape

1	FPC or H/S black tape shift (minor defect)	1.shift spec: 1)glue to the polarize 【Reject】 2) IC bare 【Reject】 2. left-and-right spec: 1) exceed of FPC edge or H-S edge 【Reject】 2)IC bare 【Reject】	
2	No black tape (Major defect)	No black tape 【Reject】	
3	Tape position mistake (minor defect)	Not by engineering drawing 【Reject】	
4	Mara tape defect (minor defect)	Peel before pulling the protecting film. 【Reject】	

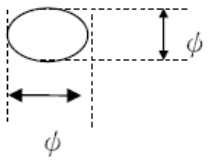
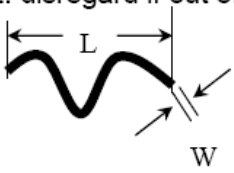
3.1.5 Silicon and Tuffy glue

No	Defect item	Criteria	Remark
1	Quantity of silicon (minor defect)	Uncover the ITO and circuit area. 【Reject】	note: compared by engineering drawing.

No	Defect item	Criteria	Remark
2	Tuffy glue (minor defect)	1. Uncover the reveal copper area 【Reject】 2. Cover layer 0.3mm(Min) ~ 3.0mm(Max) 【accept】	note:if customer has special requirement , refer to the technical document. 
3	Depth of glue covering (minor defect)	Depth of glue covering overtop front Polarizer 【Reject】	Except of the special requirement。

3.2 Electrical criteria

No	Defect item	Criteria	Remark
1	No display (Major defect)	No display 【Reject】	
2	Missing line (Major defect)	Missing line 【Reject】	
3	Seg-com light and dark (Major defect)	Seg-com light and dark 【Reject】	ND filter 2% test
4	No display in immobility (Major defect)	No display in immobility 【Reject】	
5	Flicker of Pattern (Major defect)	Flicker of Pattern 【Reject】	
6	Mura (Major defect)	ND filter 2% test	
7	Over current (Major defect)	Over current 【Reject】	
8	Voltage out of specification (Major defect)	Voltage out of specification 【Reject】	
9	Pattern blur ,error code (Major defect)	Pattern blur ,error code 【Reject】	
10	Dark light, Flicker (Major defect)	Dark light, Flicker 【Reject】	

No	Defect item	Criteria	Remark	
11	Black/White dots 、Dirty dots 、eyewinker (Major defect)	Specification	Allowable	Note1: disregard if out of AA 
		ψ≦0.15mm	disregard	
		0.15mm<ψ ≦ 0.25mm	2	
		0.25mm<ψ ≦ 0.3mm	1	
		0.3mm<ψ	0	
12	Fiber 、glass cratch 、 polarizer scratch/folded (minor defect)	W≦0.03mm	disregard	note1: L : Length 、W : Width note2: disregard if out of AA 
		0.03mm<W≦0.05mm ; L≦3.0mm	2	
		0.05mm<W≦0.1mm; L≦3.0mm	1	
		W>0.1mm ; L>3.0mm	0	

12. Precautions For Using LCD Modules

Please pay attentions to the followings as using the LCD module.

12.1 Handling

(a) Do not apply strong mechanical stress like drop, shock or any force to LCD module. It may cause improper operation, even damage.

(b) Because the ITO film very fragile and easy to be damaged, do not hit, press or rub the display surface with hard materials.

(c) Do not put heavy or hard material on the display surface, and do not stack LCD modules.

(d) If the display surface is dirty, please wipe the surface softly with cotton swab or clean cloth.

(e) Wipe off water droplets or oil immediately.

(f) Protect the LCD module from ESD. It will damage the LSI and the electronic circuit.

(g) Do not touch the output pins directly with bare hands.

(h) Do not disassemble the LCD module.

12.2 Storage

(a) Do not leave the LCD modules in high temperature, especially in high humidity for a long time.

(b) Do not expose the LCD modules to sunlight directly.

(c) The liquid crystal is deteriorated by ultraviolet. Do not leave it in strong ultraviolet ray for a long time.

(d) Avoid condensation of water. It may cause improper operation.

(e) Please stack only up to the number stated on carton box for storage and transportation. Excessive weight will cause deformation and damage of carton box.

12.3 Operation

(a) When mounting or dismounting the LCD modules, turn the power off.

(b) Protect the LCD modules from electric shock.

(c) The Driver IC control algorithms stated above should always obeyed to avoid damaging the LSI and electronic circuit.

(d) Be careful to avoid mixing up the polarity of power supply for backlight.

(e) Absolute maximum rating specified above has to be always kept in any case. Exceeding it may cause non-recoverable damage of electronic components or, nevertheless, burning.

(f) When a static image is displayed for a long time, remnant image is likely to occur.

(g) Be sure to avoid bending the FPC to an acute shape, it might break FPC.

12.4 Others

(a) If the liquid crystal leaks from the panel, it should be kept away from the eyes or mouth.

(b) It is recommended to peel off the protection film on the ITO film slowly so that the electrostatic charge can be minimized.

(c) It is recommended to peel off the protection film on the polarizer slowly so that the electrostatic charge can be minimized.

13. Records Of Version

Version	Revise Date	Page	Content
v1.5	2020-4-13	All	New released